

# WI Series

## SMD Power Inductor

### Size 4532



#### CHARACTERISTICS

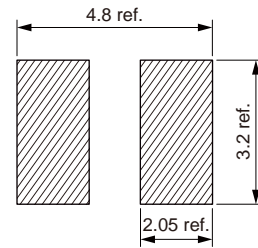
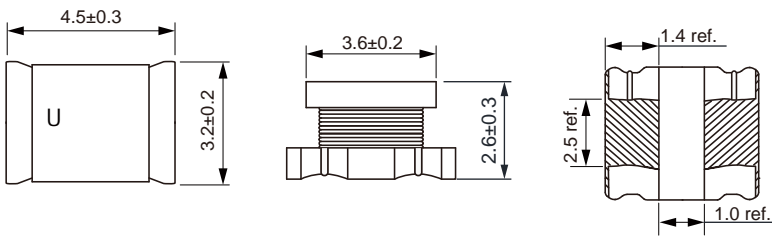
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#### APPLICATION

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Dimensions: [mm]

Land Pattern: [mm]

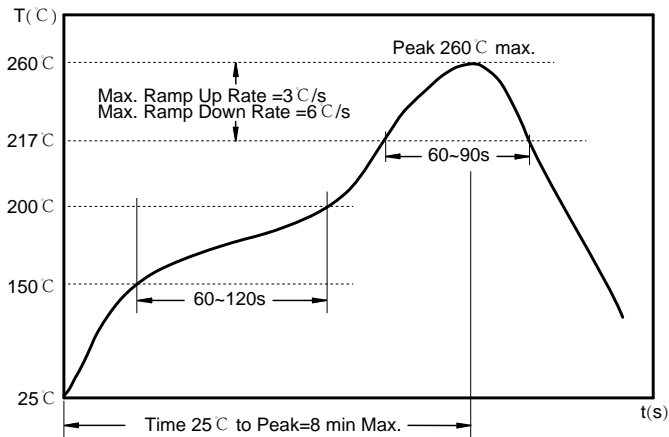


Electrical Properties:

Part No	Inductance (μH)	Test Conditions	Tolerance	DC Resistance MAX. (Ω)	SRF Min. (MHz)	Saturation Current Max. (A)
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† @ k U	.	U =- †				.
† @ k U	.	U =- †				.
† @ k U	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	U =- †				.
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† @ M	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	U =- †				.
† @ M	.	M =- †				.
† @ M	.	M =- †				.
† @ M	.	M =- †				.

Saturation Current will cause L to drop approximately 10%

## Soldering Reflow:



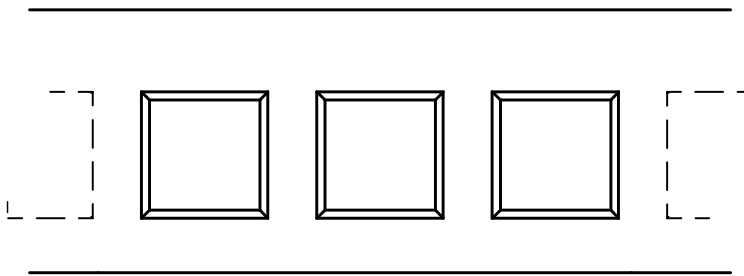
Preheat condition: 150 ~200 °C / 60~120 sec.

Allowed time above 217 °C : 60~90 sec.

Max temperature: 260 °C .

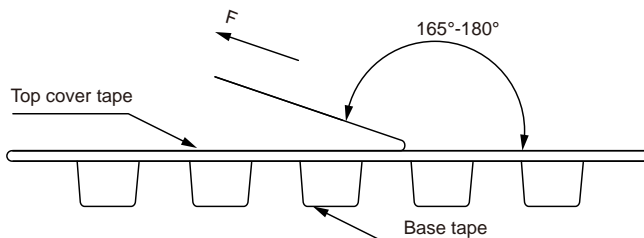
## Packaging Information:

### Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
WI4532	3.45± 0.1	4.70± 0.1	1.5± 0.1	4.0± 0.1	8.0± 0.1	12.0± 0.3	3.15± 0.1	1.75± 0.1	0.40± 0.05

### Peel force of top cover tape:

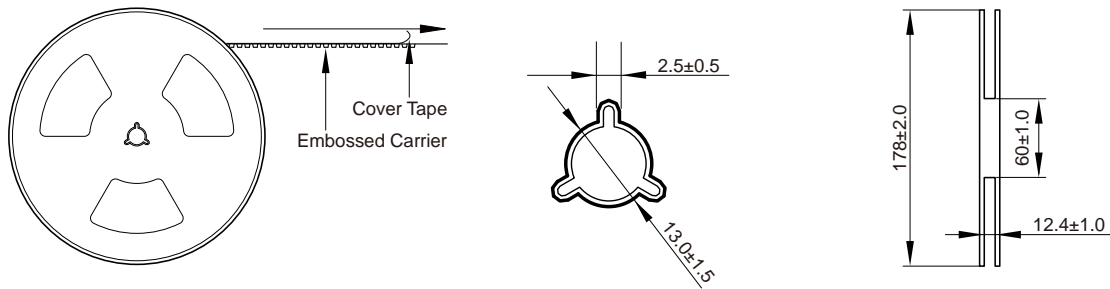


The peel force of top cover tape shall be between 0.3 to 1.17 N

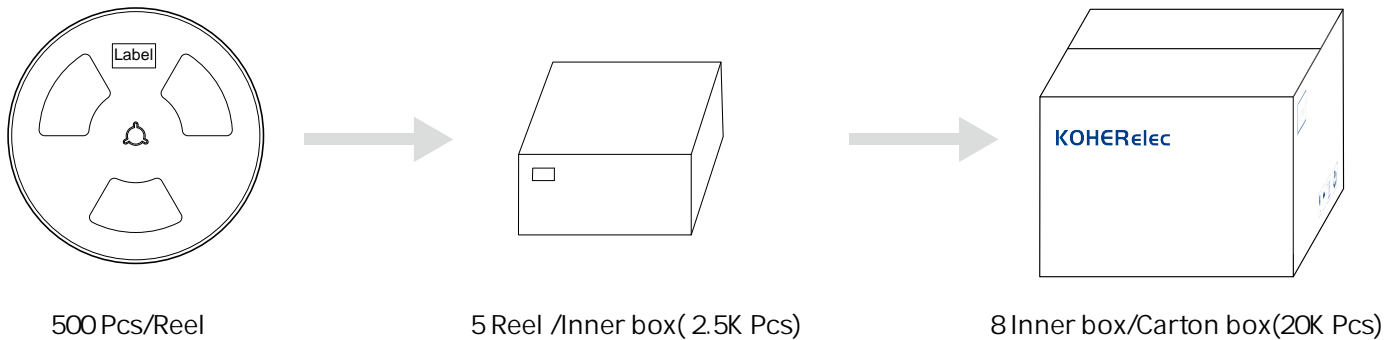
### Product Marking:

Marking	Printing Inductance)
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## Reel Dimension: [mm]



## Packaging Quantity:



## Cautions and Warnings:

### Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

### Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.